



# Product Change Notification

## 104394 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geography location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

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# Product Change Notification

**Change Notification #:** 104394 - 00  
**Change Title:** D915GAG, PCN 104394-00, FFF, Added Mounting hole, Front Side Bus Circuit enhancements  
**Date of Publication:** September 08, 2004

**Type of Change Notification:**  
FFF - (Form-Fit-Function)

**Key Characteristics of the Change:**  
Product Design

## Forecasted Key Milestones:

<b>Date of First Availability of Post-Conversion Material:</b>	Oct 04, 2004
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*The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.*

## Description of Change to the Customer:

1. Added mounting hole G from ATX 2.2 spec (near the PCI slots)
2. Added resistor to Front Side Bus circuit to enhance high side margins

## Customer Impact of Change and Recommended Action:

These changes are not expected to affect the Microsoft\* Windows\* operating system's software driver stack, or software image stack. The changes have been thoroughly evaluated to ensure that there is no quality, reliability or hardware functional implications to our customers.

## Products Affected / Intel Ordering Codes:

### Board Products Table

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA or AA	Post-Change TA or AA	Pre-Change PBA	Post-Change PBA
LAD915GAVL	859824	859824	C66813-301	C66813-400	C64137-301	C64137-400

## Reference Documents / Attachments:

**Document:** \_\_\_\_\_ **Location #:** \_\_\_\_\_

**PCN Revision History:**

**Date of Revision:**  
September 8, 2004

**Revision Number:**  
00

**Reason:**  
Originally Published PCN